TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC74ACT08P, TC74ACT08F, TC74ACT08FN, TC74ACT08FT

QUAD 2-INPUT AND GATE

The TC74ACT08 is an advanced high speed CMOS 2-INPUT AND GATE fabricated with silicon gate and double - layer metal wiring C2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

This device may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

FEATURES:

- High Speed······ t_{pd} = 4.7ns(typ.) at V_{CC} = 5V
- Low Power Dissipation ············ $I_{CC} = 4\mu A(Max.)$ at Ta = 25°C
- Compatible with TTL outputs $\cdots V_{1L} = 0.8V$ (Max.)

$$V_{IH} = 2.0V (Min.)$$

• Symmetrical Output Impedance··· $| I_{OH} | = I_{OL} = 24$ mA(Min.)

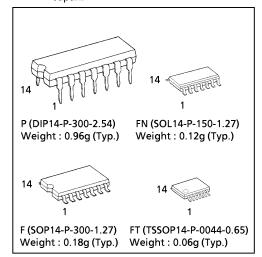
Capability of driving 50 Ω

transmission lines.

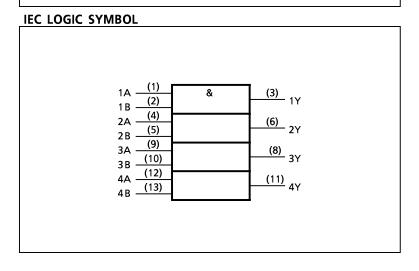
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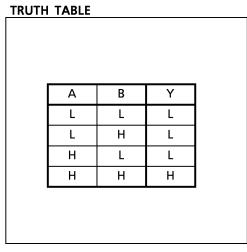
- \bullet Balanced Propagation Delays….. $t_{pLH}{\simeq}t_{pHL}$
- Pin and Function Compatible with 74F08

(Note) The JEDEC SOP (FN) is not available in Japan.



PIN ASSIGNMENT 1A 14 V_{CC} 13 4 B 3 4A **1Y** 12 2A 4 4Y 11 2 B 5 3 B 10 6 2Y 3A GND 7 **3**Y (TOP VIEW)





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ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage Range	V _{cc}	-0.5~7.0	V
DC Input Voltage	V _{IN}	$-0.5 \sim V_{CC} + 0.5$	٧
DC Output Voltage	V _{OUT}	$-0.5 \sim V_{CC} + 0.5$	V
Input Diode Current	I _{IK}	± 20	mΑ
Output Diode Current	I _{OK}	± 50	mΑ
DC Output Current	I _{OUT}	± 50	mΑ
DC V _{CC} /Ground Current	I _{cc}	± 100	mA
Power Dissipation	P _D	500 (DIP)* /180 (SOP/TSSOP)	mW
Storage Temperature	T _{stg}	−65~150	°C

^{*500}mW in the range of Ta = -40° C ~65°C. From Ta = 65°C to 85°C a derating factor of -10mW/°C should be applied up to 300mW.

RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	VALUE	UNIT
Supply Voltage	V_{CC}	4.5~5.5	V
Input Voltage	V _{IN}	0~V _{cc}	V
Output Voltage	V _{OUT}	0~V _{cc}	V
Operating Temperature	T _{opr}	−40~85	°C
Input Rise and Fall Time	dt/dV	0~10	ns / V

DC ELECTRICAL CHARACTERISTICS

PARAMETER SYMBOL		TEST CONDITION		V _{CC}	Ta = 25°C			Ta = -40~85°C		UNIT
PARAIVIETER	SYMBOL	MBOL TEST CONDITION		(V)	MIN.	TYP.	MAX.	MIN.	MAX.	OINIT
High - Level Input Voltage	V _{IH}			4.5 \$ 5.5	2.0	1	ı	2.0	1	V
Low - Level Input Voltage	VIL			4.5 \$ 5.5	_	_	0.8	_	0.8	V
High - Level Output Voltage	V _{OH}	$V_{IN} = V_{IH}$	$I_{OH} = -50 \mu A$ $I_{OH} = -24 m A$ $I_{OH} = -75 m A^*$	4.5 4.5 5.5	4.4 3.94 —	4.5 _ _	1 1 1	4.4 3.80 3.85	111	V
Low - Level Output Voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	$I_{OL} = 50 \mu A$ $I_{OL} = 24 m A$ $I_{OL} = 75 m A*$	4.5 4.5 5.5	111	0.0 - -	0.1 0.36 —	111	0.1 0.44 1.65	V
Input Leakage Current	I _{IN}	$V_{IN} = V_{CC}$ or GND		5.5			± 0.1		± 1.0	
I_{CC} $V_{IN} = V_{CC}$ or GND		5.5	1		4.0		40.0	μ A		
Quiescent Supply Current	I _C	PER INPUT : V _{II} OTHER INPUT	5.5	_	_	1.35	=	1.5	mA	

^{* :} This spec indicates the capability of driving 50Ω transmission lines. One output should be tested at a time for a 10ms maximum duration.

AC ELECTRICAL CHARACTERISTICS (C_L = 50pF , $\,R_L$ = 500 Ω , Input $\,t_r$ = t_f = 3ns)

PARAMETER	SYMBOL	TEST CONDITION		Ta = 25°C			Ta = −40~85°C		UNIT
			V _{cc} (V)	MIN.	TYP.	MAX.	MIN.	MAX.	OINIT
Propagation Delay Time	t _{pLH} t _{pHL}		5.0 ± 0.5	_	5.4	8.7	1.0	10.0	ns
Input Capacitance	C _{IN}			_	5	10	_	10	"E
Power Dissipation Capacitance	C _{PD} (1)		·	_	21	_	_	_	pF

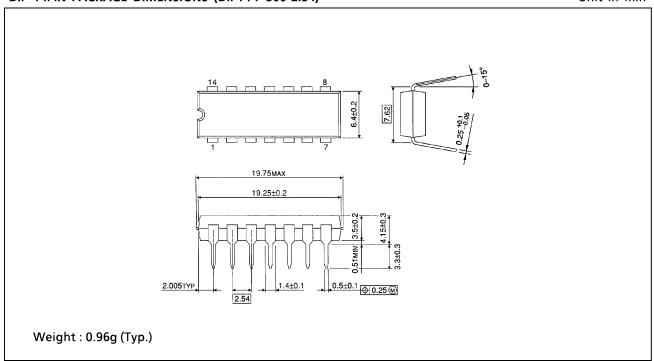
Note (1) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

$$I_{CC (opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 4 \text{ (per Gate)}$$

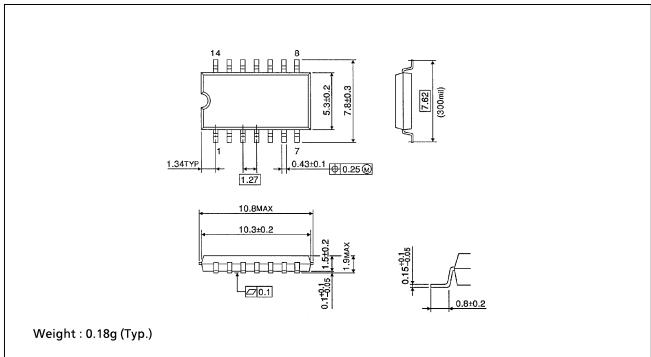
DIP 14PIN PACKAGE DIMENSIONS (DIP14-P-300-2.54)

Unit in mm



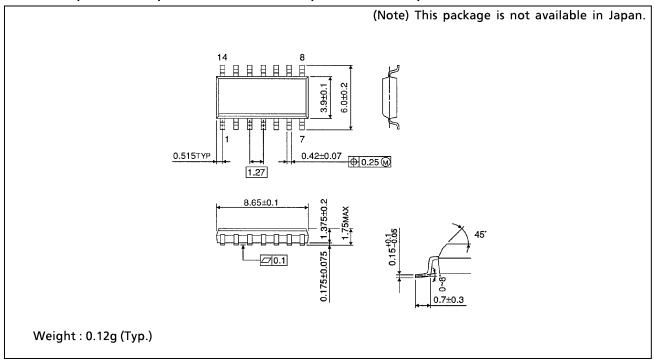
SOP 14PIN (200mil BODY) PACKAGE DIMENSIONS (SOP14-P-300-1.27)

Unit in mm



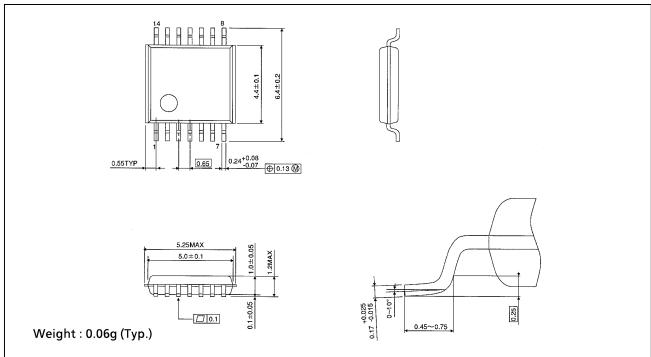
SOP 14PIN (150mil BODY) PACKAGE DIMENSIONS (SOL14-P-150 -1.27)

Unit in mm



TSSOP 14PIN (170mil BODY) PACKAGE DIMENSIONS (TSSOP14-P-0044-0.65)

Unit in mm



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